

	Type	Ref #	Hits	Search Text
1	BRS	S8	1	S4 and (laser\$1 LD\$1) same (first second thrid fourth groov\$2) same (waveguide\$1)
2	BRS	S4	1	"10/534438"
3	BRS	S7	1	S4 and (laser\$1 LD\$1) and (first second thrid fourth groov\$2) same (waveguide\$1)
4	BRS	S9	1	S4 and (thrid fourth groov\$2) and ((end\$2 face) near7 (laser device waveguide\$1))
5	BRS	S10	1	S4 and (thrid fourth) near7 groov\$2 and ((end\$2 face) near7 (laser device waveguide\$1))
6	BRS	S11	1	S4 and (thrid fourth) near7 groov\$2
7	BRS	S12	1	(JP3156444 "3156444")
8	BRS	S13	1	JP3156444 JP adj1 "3156444" "3156444"
9	BRS	S14	1	S4 and (blue harmon\$4)
10	BRS	S15	433	(adher\$4 resin\$2 adhesiv\$2 apox\$4) near12 groove\$1 same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser)
11	BRS	S16	34	(adher\$4 resin\$2 adhesiv\$2 apox\$4) near12 groove\$1 same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
12	BRS	S17	23	(adher\$4 resin\$2 adhesiv\$2 apox\$4) near7 groove\$1 same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
13	BRS	S18	193	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near7 (trench\$2 groove\$1) same (waveguide\$1 fiber\$1 fibre\$1 emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)

	DBs	Time Stamp
1	US-PGPUB; USPAT	2006/11/29 15:17
2	US-PGPUB; USPAT	2006/11/29 16:56
3	US-PGPUB; USPAT	2006/11/29 15:41
4	US-PGPUB; USPAT	2006/11/29 15:42
5	US-PGPUB; USPAT	2006/11/29 16:29
6	US-PGPUB; USPAT	2006/11/29 16:32
7	JPO; DERWENT	2006/11/29 16:34
8	JPO; DERWENT	2006/11/29 16:55
9	US-PGPUB; USPAT	2006/11/29 17:15
10	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/29 17:20
11	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/29 17:22
12	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 16:34
13	JPO; DERWENT	2006/11/29 17:27

	Type	Ref #	Hits	Search Text
14	BRS	S20	78	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near5 (trench\$2 groove\$1) same (waveguide\$1 emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
15	BRS	S19	142	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near7 (trench\$2 groove\$1) same (waveguide\$1 fiber\$1 fibre\$1 emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
16	BRS	S21	1	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near5 (trench\$2 groove\$1) same (waveguide\$1) same (emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
17	BRS	S22	2	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near5 (trench\$2 groove\$1) same (waveguide fiber fibre) same (emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
18	BRS	S23	40	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near5 (trench\$2 groove\$1) same (waveguide fiber fibre) same (emit\$4 semiconductor LD\$1 laser)
19	BRS	S24	347	(adher\$4 resin\$2 adhesiv\$2 apox\$4) near7 groove\$1 same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser)
20	BRS	S29	163	S26 and S27 and S28
21	BRS	S25	23	(adher\$4 resin\$2 adhesiv\$2 apox\$4) near7 groove\$1 same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser) same (thermal temperatur\$2)
22	BRS	S28	453	(adher\$4 resin\$2 adhesiv\$2 apox\$4) near12 (trench\$3 groove\$1) same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser)
23	BRS	S27	2536	(trench\$2 groove\$1) near9 (waveguide\$1 fiber\$1 fibre\$1) near12 (emit\$4 semiconduct\$3 LD\$1 laser source)

	DBs	Time Stamp
14	JPO	2006/11/29 17:28
15	JPO	2006/12/04 13:07
16	JPO	2006/11/29 17:29
17	JPO	2006/11/29 17:30
18	JPO	2006/11/30 16:46
19	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/29 17:37
20	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:07
21	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 16:35
22	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:06
23	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 16:41

	Type	Ref #	Hits	Search Text
24	BRS	S26	1338	(trench\$2 groove\$1) near9 (waveguide\$1 fiber\$1 fibre\$1) near12 (emit\$4 semiconductor LD\$1 laser source) same (submount substrate mount base)
25	BRS	S38	1	S35 and (groov\$2 near12 resin\$2)
26	BRS	S34	110	S32 not (S30 S31)
27	BRS	S37	0	S35 and (groov\$2 near7 resin\$2)
28	BRS	S59	9	("6141471" "5007700" "20020051607" "20020037143" "20060034570" "6257772" "20020048436" "20010033722" "6371664") .pn.
29	BRS	S31	9	S29 not S30
30	BRS	S30	40	(adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near5 (trench\$2 groove\$1) same (waveguide fiber fibre) same (emit\$4 semiconductor LD\$1 laser)
31	BRS	S32	118	S29 and ((second third fourth) adj1 (trench groove) trenches grooves)
32	BRS	S39	0	S34 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near11 (thermal\$3 temperatur\$2)
33	BRS	S35	1	"20020001427".pn.
34	BRS	S36	0	S35 and (groov\$2 near5 resin\$2)
35	BRS	S43	22	S40 and (adher\$4 resin\$2 adhesiv\$2 apox\$4) near5 (trench\$3 groove\$1)
36	BRS	S44	41	S34 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) same (thermal\$3 temperatur\$2)
37	BRS	S41	28	S34 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near11 (thermal\$3 temperatur\$2)
38	BRS	S42	0	11/396185
39	BRS	S40	28	S34 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near11 (thermal\$3 temperatur\$2)

	DBs	Time Stamp
24	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 16:39
25	US-PGPUB; USPAT	2006/11/30 17:45
26	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 17:51
27	US-PGPUB; USPAT	2006/11/30 17:45
28	US-PGPUB; USPAT	2006/11/30 20:20
29	JPO	2006/11/30 16:47
30	JPO	2006/11/30 17:52
31	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:09
32	JPO	2006/11/30 17:53
33	US-PGPUB; USPAT	2006/11/30 17:44
34	US-PGPUB; USPAT	2006/11/30 17:44
35	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 19:57
36	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:10
37	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 19:55
38	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 18:16
39	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 18:16

	Type	Ref #	Hits	Search Text
40	BRS	S47	12	S45 and (adher\$4 resin\$2 adhesiv\$2 epox\$4) near5 (trench\$3 groove\$1)
41	BRS	S48	88	(epox\$4) near12 (trench\$3 groove\$1) same (waveguide\$1 fiber\$1 fibre\$1) same (emit\$4 semiconductor LD\$1 laser)
42	BRS	S50	18	S49 not (S40 S45)
43	BRS	S45	19	S44 not S43
44	BRS	S46	12	S45 and (adher\$4 resin\$2 adhesiv\$2 apox\$4) near5 (trench\$3 groove\$1)
45	BRS	S49	18	S26 and S27 and S48
46	BRS	S53	13	S52 and ((second third fourth) adj1 (trench groove) trenches grooves)
47	BRS	S51	18	S49 not (S25 S30)
48	BRS	S52	18	S49 not (S31)
49	BRS	S55	0	"6141471, pn."
50	BRS	S54	0	S53 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) same (thermal\$3 temperatur\$2)
51	BRS	S56	2	"6141471".pn.
52	BRS	S57	0	S56 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near7 (fiber\$1 waveguide\$1)
53	BRS	S60	13	S53 and (adher\$4 resin\$2 adhesiv\$2 epox\$4 paste) near9 (waveguide\$1 fiber\$1 fibre\$1 emit\$4 semiconductor\$3 LD\$1 laser source trench\$2 groove\$1)
54	BRS	S58	0	S56 and (adher\$4 resin\$2 adhesiv\$2 apox\$4 paste) near7 (fiber\$1 fibre\$1 waveguide\$1)
55	BRS	S62	8	S59 and (adher\$4 resin\$2 adhesiv\$2 epox\$4 paste) near9 (waveguide\$1 fiber\$1 fibre\$1 )
56	BRS	S61	9	S59 and (adher\$4 resin\$2 adhesiv\$2 epox\$4 paste) near9 (waveguide\$1 fiber\$1 fibre\$1 emit\$4 semiconductor\$3 LD\$1 laser source trench\$2 groove\$1)

	DBs	Time Stamp
40	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 19:58
41	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:06
42	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:08
43	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 19:57
44	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 19:58
45	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:07
46	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:10
47	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:09
48	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:09
49	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:17
50	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:20
51	US-PGPUB; USPAT; EPO; JPO; DERWENT	2006/11/30 20:18
52	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:18
53	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:24
54	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:18
55	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:25
56	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/11/30 20:24

	Type	Ref #	Hits	Search Text
57	BRS	S63	8	S61 and (adher\$4 resin\$2 adhesiv\$2 epox\$4 paste) near9 (waveguide\$1 fiber\$1 fibre\$1 )

	DBs	Time Stamp
57	US-PGPUB; USPAT; FPRS; EPO; JPO	2006/12/04 12:25

Day : Monday  
Date: 12/4/2006

Time: 16:21:50

**PALM INTRANET****Inventor Name Search Result**

Your Search was:

Last Name = MORIKAWA

First Name = AKIHIRO

Application#	Patent#	Status	Date Filed	Title	Inventor Name
<a href="#"><u>10123892</u></a>	6829080	150	04/16/2002	OPTICAL WAVEGUIDE DEVICE AND LIGHT SOURCE AND OPTICAL APPARATUS USING THE SAME	MORIKAWA, AKIHIRO
<a href="#"><u>10220100</u></a>	6847660	150	12/04/2002	SHORT- WAVELENGTH LASER MODULE AND METHOD OF MANUFACTURING THE LASER MODULE	MORIKAWA, AKIHIRO
<a href="#"><u>10534438</u></a>	Not Issued	30	05/10/2005	LASER MODULE AND METHOD FOR MANUFACTURING THE SAME	MORIKAWA, AKIHIRO
<a href="#"><u>10535975</u></a>	Not Issued	30	05/24/2005	Method for forming domain-inverted structure and optical element with domain-inverted structure	MORIKAWA, AKIHIRO
<a href="#"><u>10555941</u></a>	Not Issued	20	11/07/2005	Electric switch and memory device using the same	MORIKAWA, AKIHIRO
<a href="#"><u>10576067</u></a>	Not Issued	20	04/14/2006	Laser image display apparatus	MORIKAWA, AKIHIRO
<a href="#"><u>10584247</u></a>	Not Issued	19	01/01/0001	Two-dimensional image display device	MORIKAWA, AKIHIRO
<a href="#"><u>10593866</u></a>	Not Issued	19	01/01/0001	Optical element and method for forming domain inversion regions	MORIKAWA, AKIHIRO
<a href="#"><u>10991560</u></a>	Not Issued	80	11/18/2004	Short-wavelength laser module and method of producing the same	MORIKAWA, AKIHIRO

Inventor Search Completed: No Records to Display.

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Search Another: Inventor

First Name

MORIKAWA	AKIHIRO	Search
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